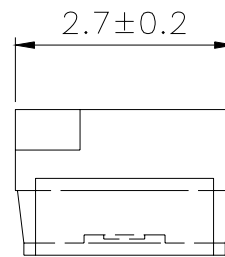
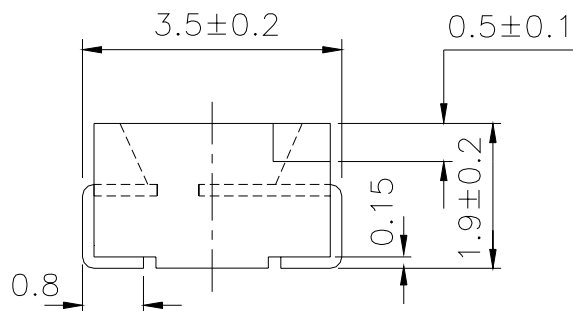
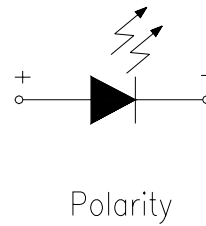
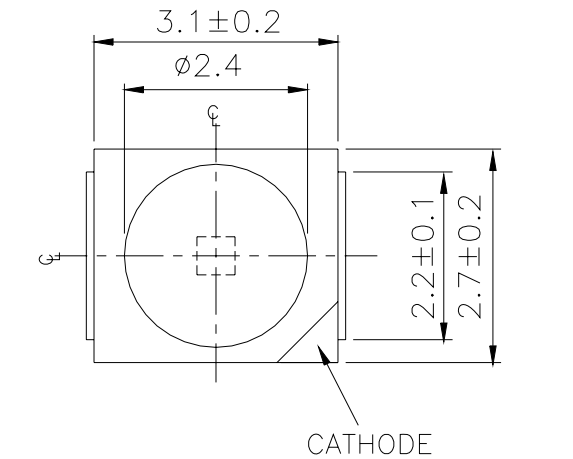


Technical Data Sheet

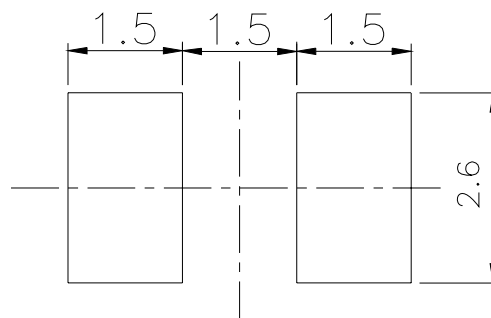
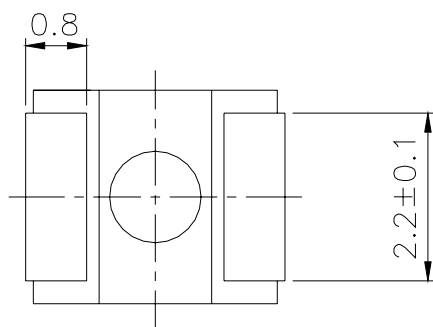
Top View LEDs

67-21SYGC/S530-XX/TR8

Package Dimensions



For reflow soldering (Proposal)



Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

**Technical Data Sheet****Top View LEDs****67-21SYGC/S530-XX/TR8****Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Peak Forward Current (Duty 1/10 @ 1 KHz)	I _{FP}	60	mA
Power Dissipation	P _d	60	mW
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40~ +100	°C
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

Technical Data Sheet

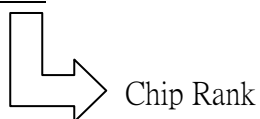
Top View LEDs

67-21SYGC/S530-XX/TR8

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip Rank	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _V	E1	16	22	-----	mcd	I _F =20mA
		E2	25	37	-----		
		E3	32	51	-----		
		E4	41	61	-----		
		E5	52	74	-----		
Viewing Angle	2 θ 1/2	-----	-----	120	-----	deg	I _F =20mA
Peak Wavelength	λ p	-----	-----	575	-----	nm	I _F =20mA
Dominant Wavelength	λ d	-----	-----	573	-----	nm	I _F =20mA
Spectrum Radiation Bandwidth	△ λ	-----	-----	20	-----	nm	I _F =20mA
Forward Voltage	V _F	-----	-----	2.0	2.4	V	I _F =20mA
Reverse Current	I _R	-----	-----	-----	10	μ A	V _R =5V

*67-21SYGC/S530-XX/TR8

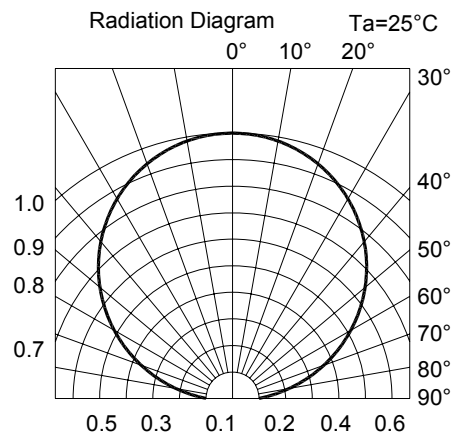
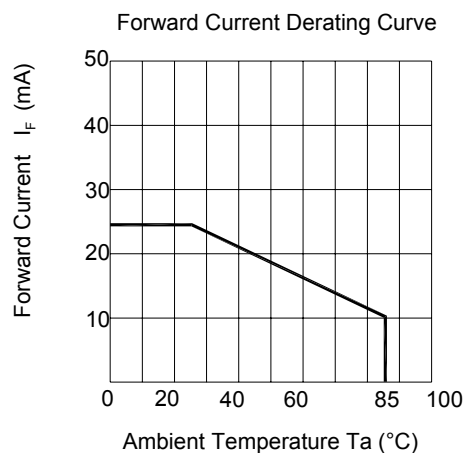
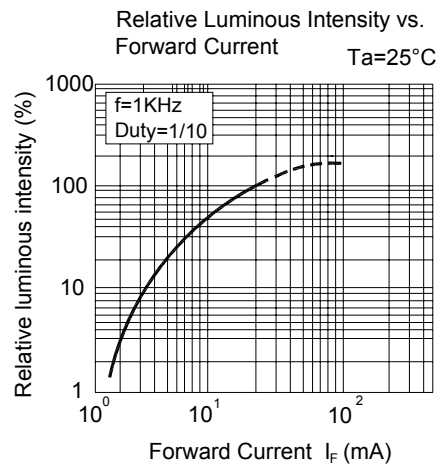
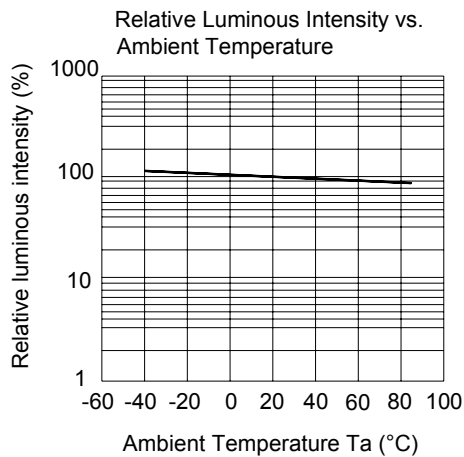
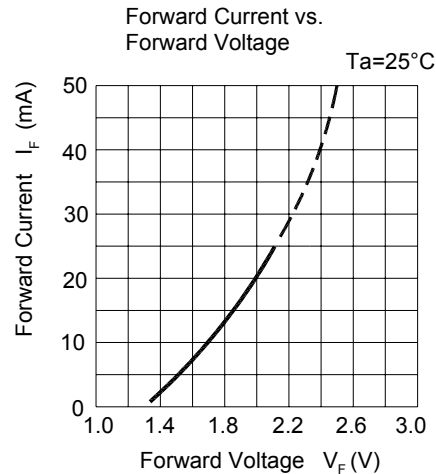
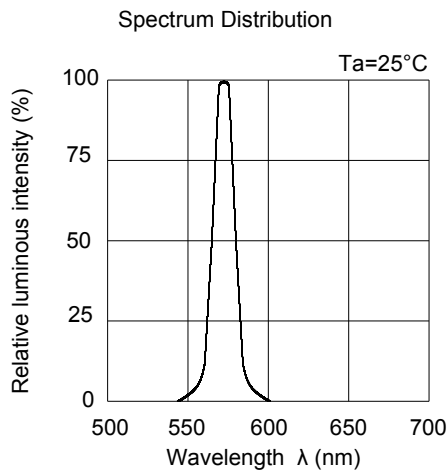


Technical Data Sheet

Top View LEDs

67-21SYGC/S530-XX/TR8

Typical Electro-Optical Characteristics Curves



Technical Data Sheet

Top View LEDs

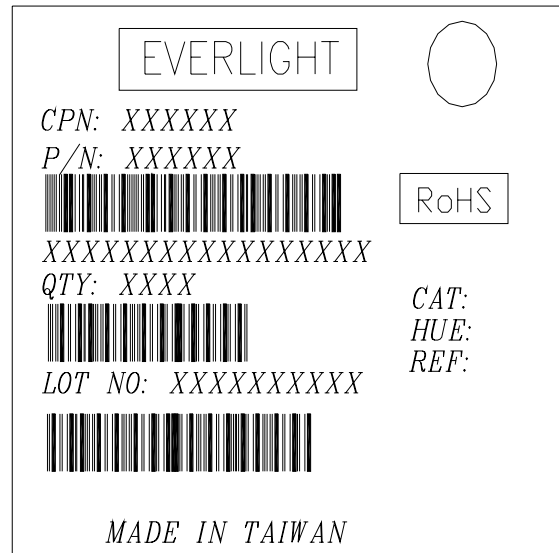
67-21SYGC/S530-XX/TR8

Label Explanation

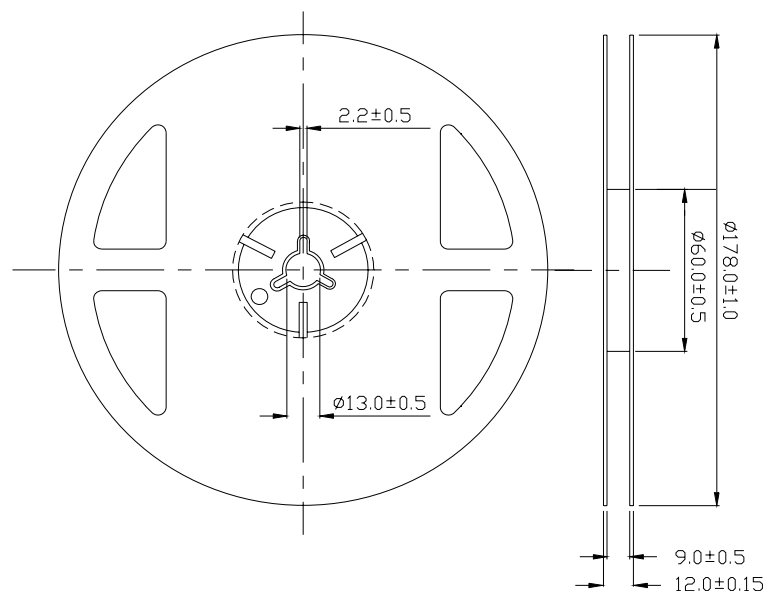
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



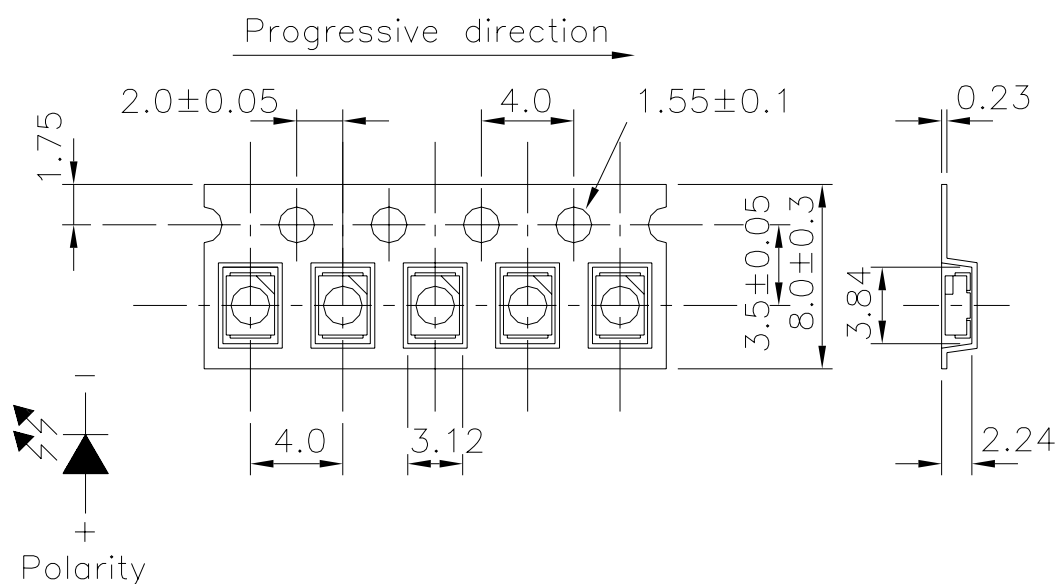
Note: Tolerance unless mentioned is $\pm 0.1\text{mm}$; Unit = mm

Technical Data Sheet

Top View LEDs

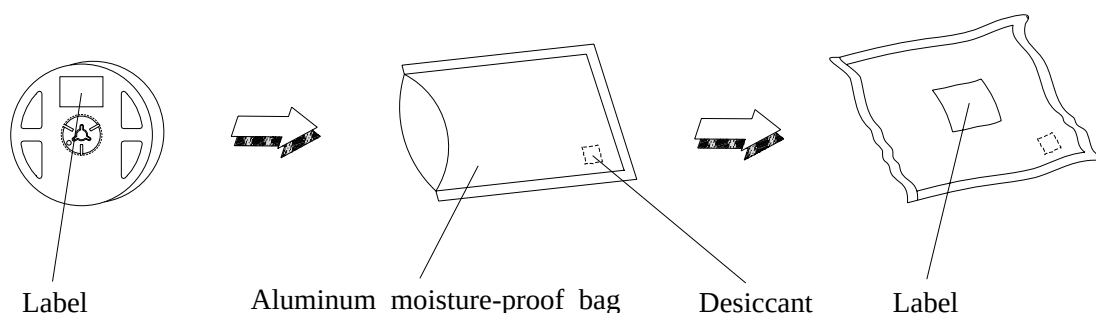
67-21SYGC/S530-XX/TR8

Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.



Note: Tolerance unless mentioned is $\pm 0.1\text{mm}$; Unit = mm

Moisture Resistant Packaging



Technical Data Sheet

Top View LEDs

67-21SYGC/S530-XX/TR8

Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I _F = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Technical Data Sheet**Top View LEDs****67-21SYGC/S530-XX/TR8****Precautions for Use****1. Over-current-proof**

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

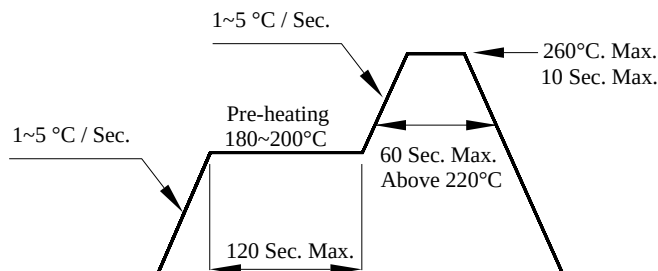
2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition**3.1 Pb-free solder temperature profile**

3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

Technical Data Sheet**Top View LEDs****67-21SYGC/S530-XX/TR8****4. Soldering Iron**

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

